



## N-Channel 80 V (D-S) MOSFET

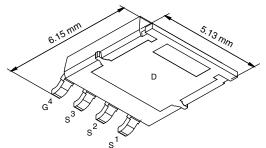
PRODUCT SUMMARY						
V <sub>DS</sub> (V)	$R_{DS(on)}$ ( $\Omega$ ) (Max.)	I <sub>D</sub> (A) <sup>a, g</sup>	Q <sub>g</sub> (Typ.)			
	0.0062 at V <sub>GS</sub> = 10 V					
80	0.0065 at V <sub>GS</sub> = 7.5 V	60	24 nC			
	0.0095 at V <sub>GS</sub> = 4.5 V					

#### **FEATURES**

- TrenchFET® Power MOSFET
- 100 % R<sub>a</sub> and UIS Tested
- Capable of Operating with 5 V Gate Drive
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912



#### PowerPAK® SO-8L Single

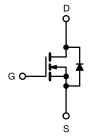


#### Ordering Information:

SiJ482DP-T1-GE3 (Lead (Pb)-free and Halogen-free)

#### **APPLICATIONS**

- DC/DC Primary Side Switch
- Synchronous Rectification
- High Current Switching



N-Channel MOSFET

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	$V_{DS}$	80	V		
Gate-Source Voltage		$V_{GS}$	± 20		
	T <sub>C</sub> = 25 °C		60 <sup>g</sup>		
Continuous Drain Current (T <sub>.I</sub> = 150 °C)	T <sub>C</sub> = 70 °C	I_	60 <sup>g</sup>		
Continuous Brain Guirent (1) = 130 C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	21.1 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		16.9 <sup>b, c</sup>	A	
Pulsed Drain Current (t = 300 μs)		I <sub>DM</sub>	100	_ ^	
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	l-	60 <sup>g</sup>		
Continuous Source-Diam Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	4.5 <sup>b, c</sup>		
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	30		
Single Pulse Avalanche Energy	L=0.111111	E <sub>AS</sub>	45	mJ	
	T <sub>C</sub> = 25 °C		69.4		
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	P <sub>D</sub>	44.4	w	
Maximum Fower Dissipation	T <sub>A</sub> = 25 °C	' b	5 <sup>b, c</sup>	7 "	
	T <sub>A</sub> = 70 °C		3.2 <sup>b, c</sup>		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150		
Soldering Recommendations (Peak Temperature) <sup>d, e</sup>			260	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient <sup>b, f</sup>	t ≤ 10 s	R <sub>thJA</sub>	20	25	°C/W
Maximum Junction-to-Case (Drain)	Steady State	$R_{thJC}$	1.3	1.8	J/VV

- a. Based on  $T_C$  = 25 °C.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. See solder profile (www.vishay.com/doc?73257). The PowerPAK SO-8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under steady state conditions is 65 °C/W.
- g. Package limited.

## SiJ482DP

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static				1			
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	80			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$			36			
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA		- 5.7		mV/°	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.5		2.7	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
		V <sub>DS</sub> = 80 V, V <sub>GS</sub> = 0 V			1		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 80 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			10	μΑ	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>DS</sub> ≥ 5 V, V <sub>GS</sub> = 10 V	30			Α	
	, ,	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A		0.0051	0.0062		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 7.5 V, I <sub>D</sub> = 15 A		0.0054	0.0065	Ω	
	-	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 10 A		0.0068	0.0095		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 20 A		68		S	
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>			2425			
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		1180		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>	50 - 7 do - 7		100		ρ.	
Therefore Transfer Capacitanies	Q <sub>g</sub>	V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A		47	71	+	
Total Gate Charge		V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 7.5 V, I <sub>D</sub> = 10 A		36.5	55	-	
3.	9	23 - 7 do - 7 D -		24	36		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 40 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$		6.6		nC	
Gate-Drain Charge	Q <sub>gd</sub>	20 / GO / D		10.2			
Output Charge	Q <sub>oss</sub>	V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V		69	105		
Gate Resistance	R <sub>g</sub>	f = 1 MHz	0.4	1.1	2.2	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			14	28		
Rise Time	t <sub>r</sub>	$V_{DD} = 40 \text{ V}, R_{I} = 4 \Omega$		11	22		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_a = 1 \Omega$		36	72	1	
Fall Time	t <sub>f</sub>	3		9	18		
Turn-On Delay Time	t <sub>d(on)</sub>			16	32	ns	
Rise Time	t <sub>r</sub>	$V_{DD} = 40 \text{ V}, R_{I} = 4 \Omega$		13	26		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 7.5 \text{ V}, R_g = 1 \Omega$		35	70		
Fall Time	t <sub>f</sub>	, and the second		11	22		
Drain-Source Body Diode Characteristic				<u> </u>			
Continuous Source-Drain Diode Current	Is	T <sub>C</sub> = 25 °C			60		
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				100	Α	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 4 A		0.73	1.1	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			46	90	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			44	86	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = 10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		21			
Reverse Recovery Rise Time	t <sub>b</sub>	-		25		ns	

#### Notes:

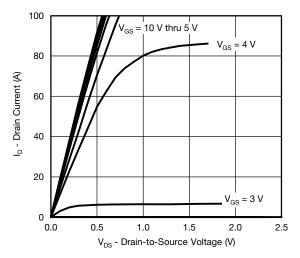
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

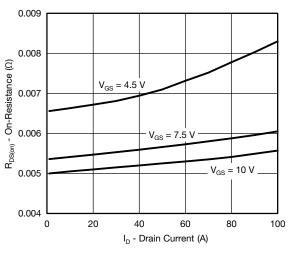
b. Guaranteed by design, not subject to production testing.



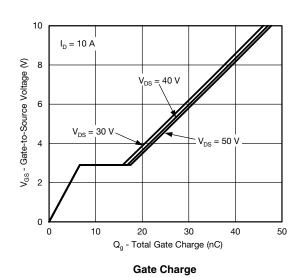
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



#### **Output Characteristics**



#### On-Resistance vs. Drain Current and Gate Voltage



10

8

(x)

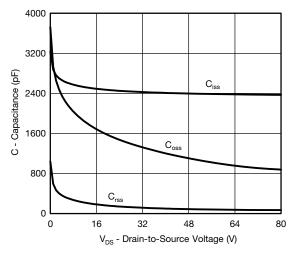
T<sub>C</sub> = 25 °C

T<sub>C</sub> = 125 °C

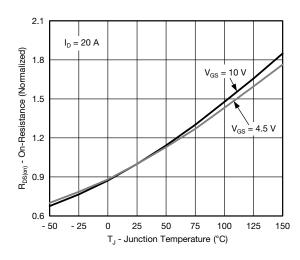
T<sub>C</sub> = -55 °C

V<sub>GS</sub> - Gate-to-Source Voltage (V)

**Transfer Characteristics** 



#### Capacitance

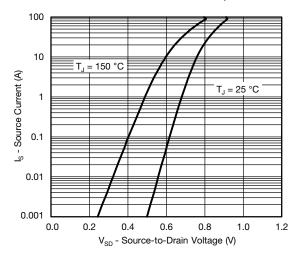


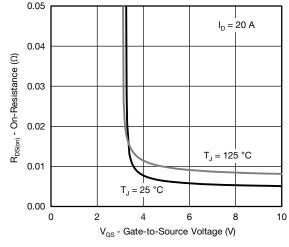
On-Resistance vs. Junction Temperature

## SiJ482DP

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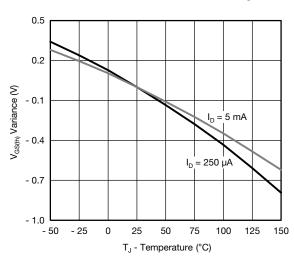
### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

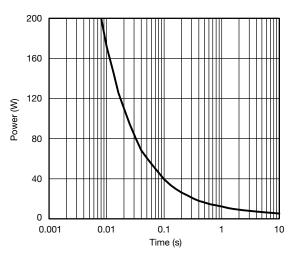




#### Source-Drain Diode Forward Voltage

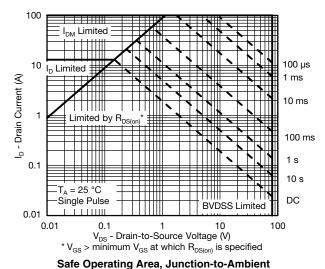






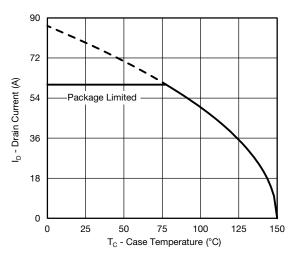
Threshold Voltage

Single Pulse Power, Junction-to-Ambient

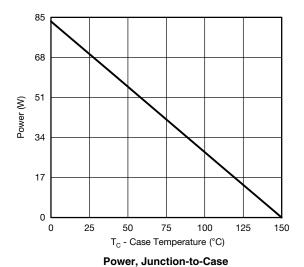


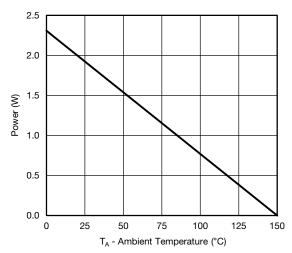


#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



#### **Current Derating\***





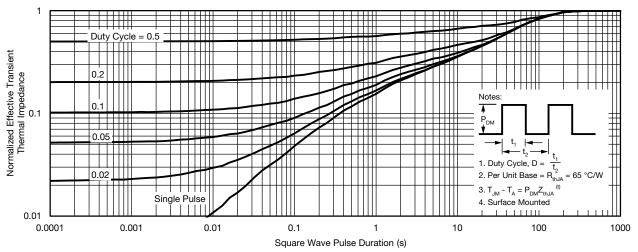
Power, Junction-to-Ambient

<sup>\*</sup> The power dissipation PD is based on TJ(max) = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

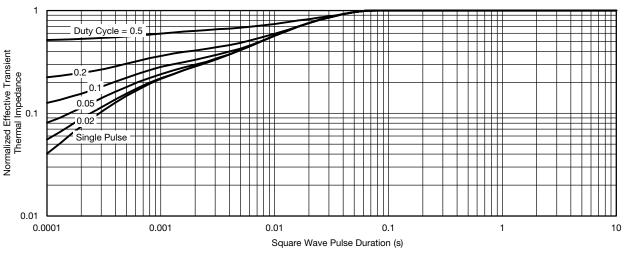
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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



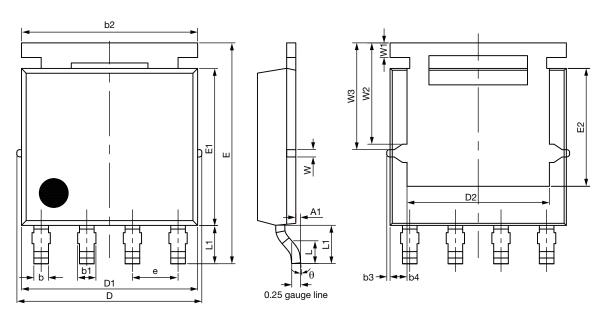
Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

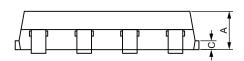
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppq?63728

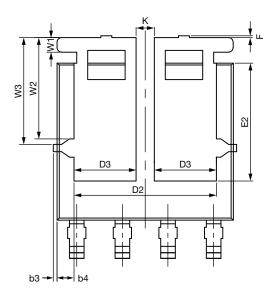
# PowerPAK® SO-8L Case Outline for Non-Al Parts



Topside view

Backside view (single)





Backside view (dual)





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DIM.	MILLIMETERS			INCHES			
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX	
Α	1.00	1.07	1.14	0.039	0.042	0.04	
A1	0.00	-	0.127	0.00	-	0.00	
b	0.33	0.41	0.48	0.013	0.016	0.019	
b1	0.44	0.51	0.58	0.017	0.020	0.023	
b2	4.80	4.90	5.00	0.189	0.193	0.197	
b3		0.094			0.004		
b4		0.47			0.019		
С	0.20	0.25	0.30	0.008	0.010	0.012	
D	5.00	5.13	5.25	0.197	0.202	0.207	
D1	4.80	4.90	5.00	0.189	0.193	0.197	
D2	3.86	3.96	4.06	0.152	0.156	0.160	
D3	1.63	1.73	1.83	0.064	0.068	0.072	
е		1.27 BSC		0.050 BSC			
Е	6.05	6.15	6.25	0.238	0.242	0.246	
E1	4.27	4.37	4.47	0.168	0.172	0.176	
E2	3.18	3.28	3.38	0.125	0.129	0.13	
F	-	-	0.15	-	-	0.006	
L	0.62	0.72	0.82	0.024	0.028	0.032	
L1	0.92	1.07	1.22	0.036	0.042	0.048	
K		0.51			0.020		
W	0.23			0.009			
W1	0.41			0.016			
W2	2.82			0.111			
W3		2.96			0.117		
θ	0°	-	10°	0°	-	10°	

ECN: T16-0221-Rev. D, 16-May-16

DWG: 5976

## Note

• Millimeters will gover



#### RECOMMENDED MINIMUM PAD FOR PowerPAK® SO-8L SINGLE



Recommended Minimum Pads Dimensions in mm (inches)



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